

Notice of References Cited	Application/Control No. 10/066,095	Applicant(s)/Patent Under Reexamination TEIG ET AL.	
	Examiner Brandon W Bowers	Art Unit 2825	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-			
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NON-PATENT DOCUMENTS

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